



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

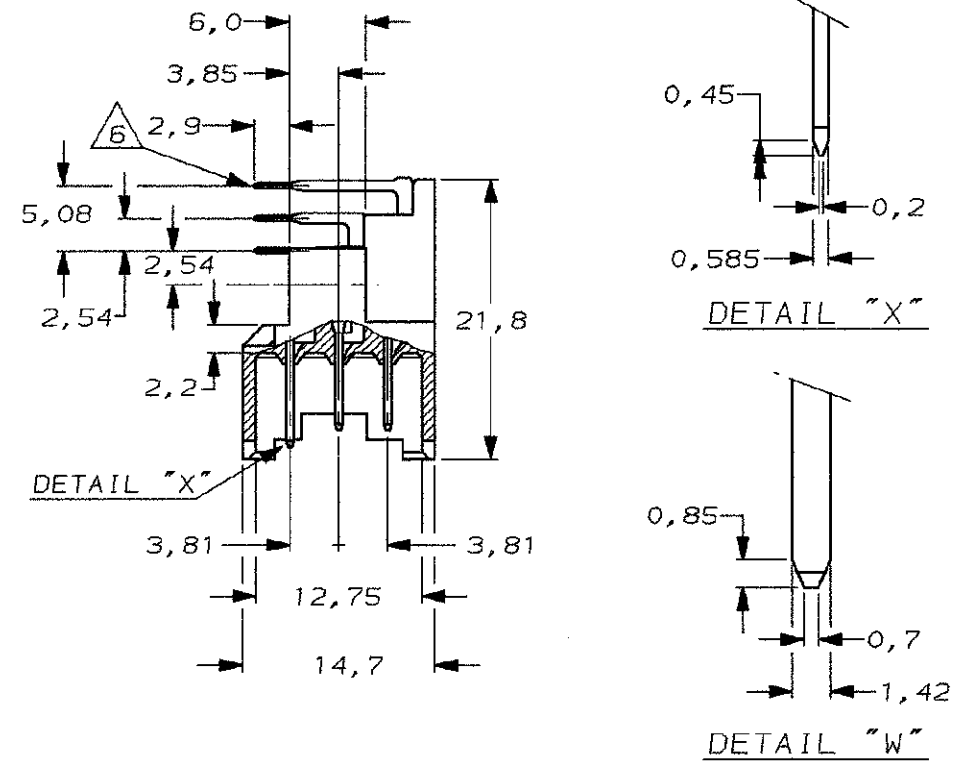
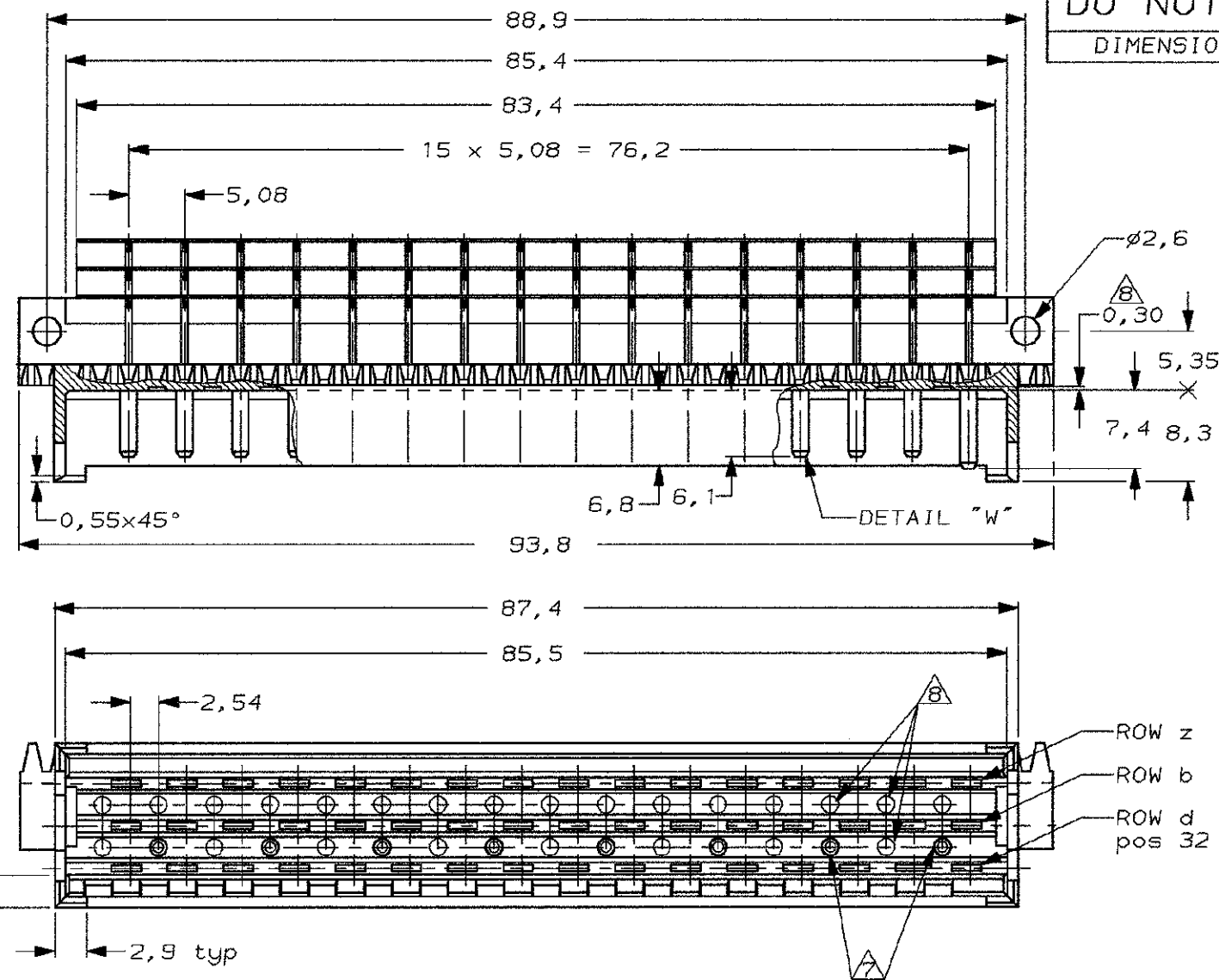
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



DO NOT SCALE  
DIMENSIONS IN mm

METRIC

THIRD ANGLE  
PROJECTION



POS. NO	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	
F 48 ROW	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X
	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X
	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X

AN ASTERISK , \* , DENOTES A STANDARD CONTACT.  
AN ASTERISK , \* , DENOTES A FMLB CONTACT.

NOTES

- 1 MATERIAL:  
-HOUSING: THERMOPLASTIC POLYESTER, COLOR GREY.  
-CONTACTS: BRASS.
- 2 PLATING CONTACT: 1,25 μm Au OVER 1,25 μm Ni IN CONTACT AREA.  
Sn/Pb over 1,25 μm Ni ON SOLDER POST.
- 3 PLATING CONTACT: 0,8 μm Au OVER 1,25 μm Ni IN CONTACT AREA.  
Sn/Pb over 1,25 μm Ni ON SOLDER POST.
- 4 PLATING CONTACT: 2,0 μm Au OVER 1,25 μm Ni IN CONTACT AREA.  
Sn/Pb over 1,25 μm Ni ON SOLDER POST.
- 5 PLATING CONTACT: 0,4 μm Au OVER 1,25 μm Ni IN CONTACT AREA.  
Sn/Pb over 1,25 μm Ni ON SOLDER POST.
- 6 SOLDER POSTS SUITABLE FOR P.C.B. HOLES  
0,8±0,05 OR 1,0±0,1 DIA.
- 7 8 HOLES SUITABLE FOR KEYING PIN PN. 215916-1.
- 8 KEYING HOLES TO BE DRILLED BY CUSTOMER.

FINISH	MATERIAL	PARTNUMBER
-	-	2-166095-8
-	-	2-166095-7
-	-	2-166095-4
-	-	2-166095-1
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<b>AMP</b>		AMP-HOLLAND B.V. 's-Hertogenbosch, The Netherlands.
F	EH-0467-96	J.G. J.G. 21-05-97
E	H-9853	R.v.l. J.v.g. 31.03.93
LTR.	REVISION RECORD	DR. CHK. DATE
DR.:	R.v.Lokven	CHK. J.GIBBELS
DATE:	31.03.93	DATE: 22-5-97
APP.:	-	DATE:
DWG.No.	C-166095	REV.LTR.
		SHEET
		1 OF 1